



# STP80N70F6

N-channel 68 V, 0.0063  $\Omega$  typ., 96 A STripFET™ VI DeepGATE™  
Power MOSFET in TO-220 package

Datasheet — production data

## Features

| Order code | V <sub>DSS</sub><br>max. | R <sub>DS(on)</sub> max.<br>(V <sub>GS</sub> = 10 V) | I <sub>D</sub> | P <sub>TOT</sub> |
|------------|--------------------------|------------------------------------------------------|----------------|------------------|
| STP80N70F6 | 68 V                     | < 0.008 $\Omega$                                     | 96 A           | 110 W            |

- R<sub>DS(on)</sub> \* Q<sub>g</sub> industry benchmark
- Extremely low on-resistance R<sub>DS(on)</sub>
- High avalanche ruggedness
- Low gate drive power losses
- Very low switching gate charge

## Applications

- Switching applications

## Description

This device is an N-channel Power MOSFET developed using the 6<sup>th</sup> generation of STripFET™ DeepGATE™ technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest R<sub>DS(on)</sub> in all packages.

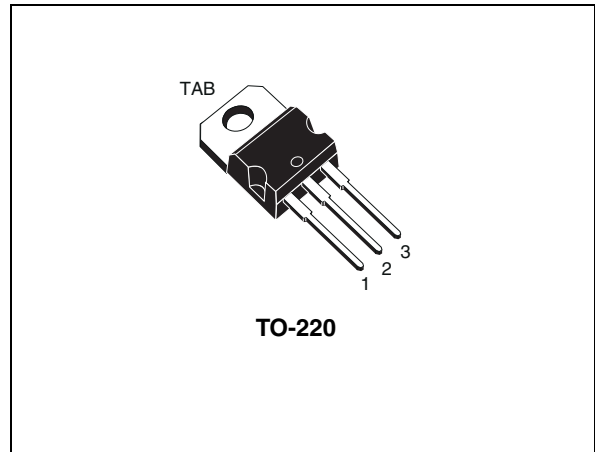


Figure 1. Internal schematic diagram

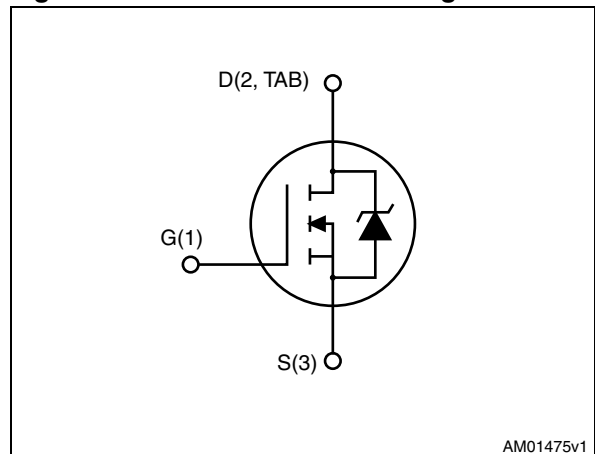


Table 1. Device summary

| Order code | Marking | Package | Packaging |
|------------|---------|---------|-----------|
| STP80N70F6 | 80N70F6 | TO-220  | Tube      |

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

| Symbol          | Parameter                                                         | Value       | Unit               |
|-----------------|-------------------------------------------------------------------|-------------|--------------------|
| $V_{DS}$        | Drain-source voltage                                              | 68          | V                  |
| $V_{GS}$        | Gate-source voltage                                               | $\pm 20$    | V                  |
| $I_D^{(1)}$     | Drain current (continuous) at $T_C = 25\text{ }^{\circ}\text{C}$  | 96          | A                  |
| $I_D^{(1)}$     | Drain current (continuous) at $T_C = 100\text{ }^{\circ}\text{C}$ | 60          | A                  |
| $I_{DM}^{(1)}$  | Drain current (pulsed)                                            | 384         | A                  |
| $P_{TOT}^{(1)}$ | Total dissipation at $T_C = 25\text{ }^{\circ}\text{C}$           | 110         | W                  |
| $T_{stg}$       | Storage temperature                                               | - 55 to 175 | $^{\circ}\text{C}$ |
| $T_j$           | Operating junction temperature                                    |             |                    |

1. This value is rated according to  $R_{thj-c}$

**Table 3. Thermal data**

| Symbol      | Parameter                               | Value | Unit                        |
|-------------|-----------------------------------------|-------|-----------------------------|
| $R_{thj-c}$ | Thermal resistance junction-case max    | 1.36  | $^{\circ}\text{C}/\text{W}$ |
| $R_{thj-a}$ | Thermal resistance junction-ambient max | 62.5  | $^{\circ}\text{C}/\text{W}$ |

## 2 Electrical characteristics

( $T_{CASE} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified).

**Table 4. On/off states**

| Symbol        | Parameter                                        | Test conditions                                                                     | Min. | Typ.   | Max.      | Unit                           |
|---------------|--------------------------------------------------|-------------------------------------------------------------------------------------|------|--------|-----------|--------------------------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage ( $V_{GS} = 0$ )  | $I_D = 250\text{ }\mu\text{A}$                                                      | 68   |        |           | V                              |
| $I_{DSS}$     | Zero gate voltage Drain current ( $V_{GS} = 0$ ) | $V_{DS} = 68\text{ V}$<br>$V_{DS} = 68\text{ V}, T_C = 125\text{ }^{\circ}\text{C}$ |      |        | 1<br>100  | $\mu\text{A}$<br>$\mu\text{A}$ |
| $I_{GSS}$     | Gate-body leakage current ( $V_{DS} = 0$ )       | $V_{GS} = \pm 20\text{ V}$                                                          |      |        | $\pm 100$ | nA                             |
| $V_{GS(th)}$  | Gate threshold voltage                           | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$                                     | 2    |        | 4         | V                              |
| $R_{DS(on)}$  | Static drain-source on-resistance                | $V_{GS} = 10\text{ V}, I_D = 48\text{ A}$                                           |      | 0.0063 | 0.008     | $\Omega$                       |

**Table 5. Dynamic**

| Symbol    | Parameter                    | Test conditions                                                                         | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|-----------------------------------------------------------------------------------------|------|------|------|------|
| $C_{iss}$ | Input capacitance            | $V_{DS} = 25\text{ V}, f = 1\text{ MHz},$<br>$V_{GS} = 0$                               | -    | 5850 | -    | pF   |
| $C_{oss}$ | Output capacitance           |                                                                                         |      | 341  |      | pF   |
| $C_{rss}$ | Reverse transfer capacitance |                                                                                         |      | 240  |      | pF   |
| $Q_g$     | Total gate charge            | $V_{DD} = 34\text{ V}, I_D = 96\text{ A},$<br>$V_{GS} = 10\text{ V}$<br>(see Figure 14) | -    | 99   | -    | nC   |
| $Q_{gs}$  | Gate-source charge           |                                                                                         |      | 31   |      | nC   |
| $Q_{gd}$  | Gate-drain charge            |                                                                                         |      | 19   |      | nC   |

**Table 6. Switching times**

| Symbol       | Parameter           | Test conditions                                                                                                 | Min. | Typ. | Max. | Unit |
|--------------|---------------------|-----------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 10\text{ V}, I_D = 48\text{ A}$<br>$R_G = 4.7\text{ }\Omega, V_{GS} = 10\text{ V}$<br>(see Figure 13) | -    | 23   | -    | ns   |
| $t_r$        | Rise time           |                                                                                                                 |      | 29   |      | ns   |
| $t_{d(off)}$ | Turn-off-delay time | (see Figure 13)                                                                                                 | -    | 102  | -    | ns   |
| $t_f$        | Fall time           |                                                                                                                 |      | 23   |      | ns   |

**Table 7. Source drain diode**

| Symbol                            | Parameter                                                                    | Test conditions                                                                                                                                 | Min. | Typ.          | Max | Unit          |
|-----------------------------------|------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|------|---------------|-----|---------------|
| $I_{SD}$                          | Source-drain current                                                         |                                                                                                                                                 | -    |               | 96  | A             |
| $I_{SDM}^{(1)}$                   | Source-drain current (pulsed)                                                |                                                                                                                                                 | -    |               | 384 | A             |
| $V_{SD}^{(2)}$                    | Forward on voltage                                                           | $I_{SD} = 96\text{ A}$ , $V_{GS} = 0$                                                                                                           | -    |               | 1.5 | V             |
| $t_{rr}$<br>$Q_{rr}$<br>$I_{RRM}$ | Reverse recovery time<br>Reverse recovery charge<br>Reverse recovery current | $I_{SD} = 48\text{ A}$ , $V_{DD} = 24\text{ V}$<br>$di/dt = 100\text{ A}/\mu\text{s}$ ,<br>$T_j = 150\text{ }^\circ\text{C}$<br>(see Figure 15) | -    | 34<br>53<br>3 |     | ns<br>nC<br>A |

1. Pulse width is limited by safe operating area
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

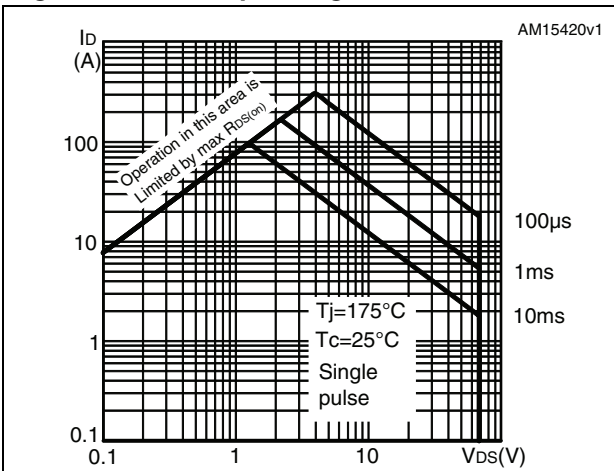


Figure 3. Thermal impedance

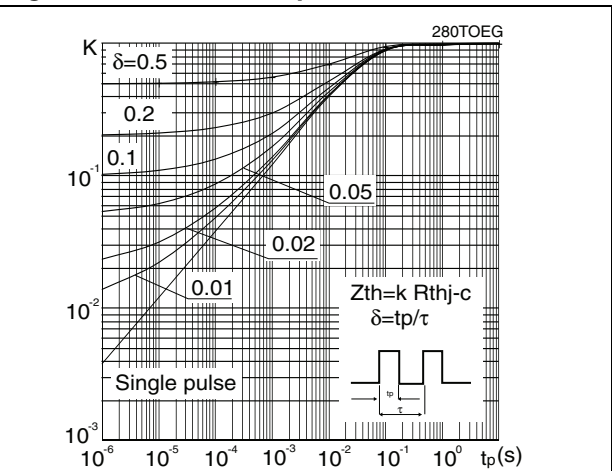


Figure 4. Output characteristics

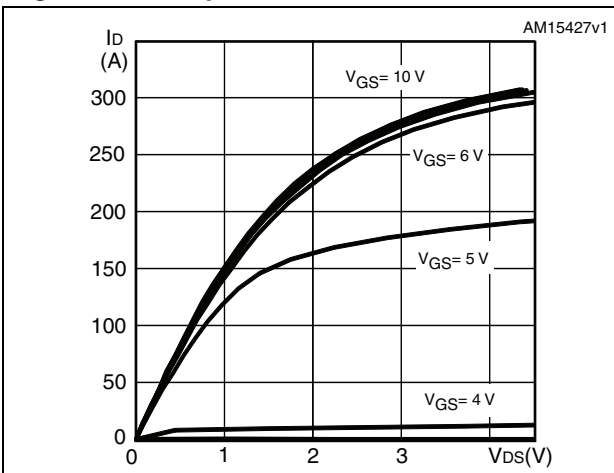


Figure 5. Transfer characteristics

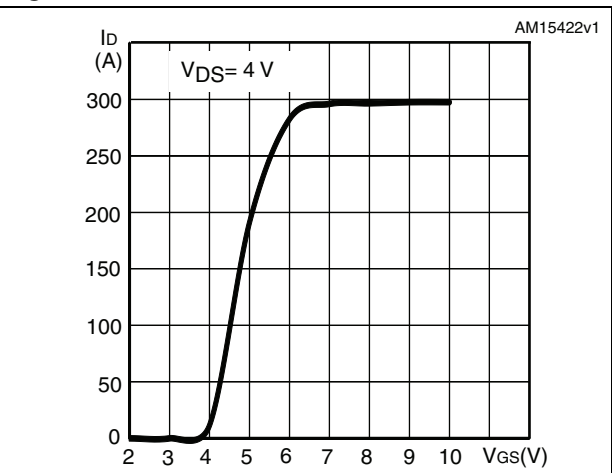


Figure 6. Gate charge vs gate-source voltage

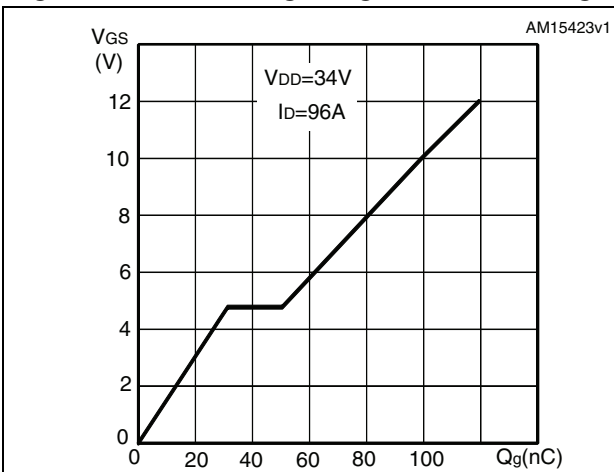


Figure 7. Static drain-source on-resistance

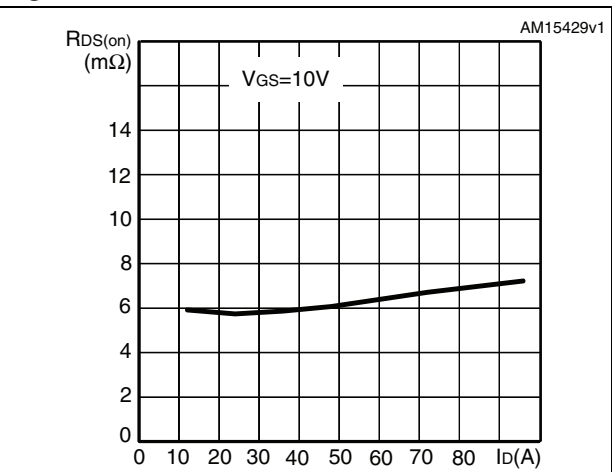


Figure 8. Capacitance variations

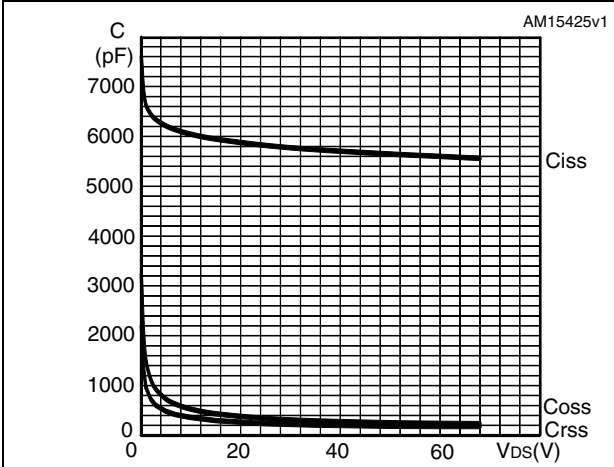


Figure 9. Normalized  $B_{V_{DS}}$  vs temperature

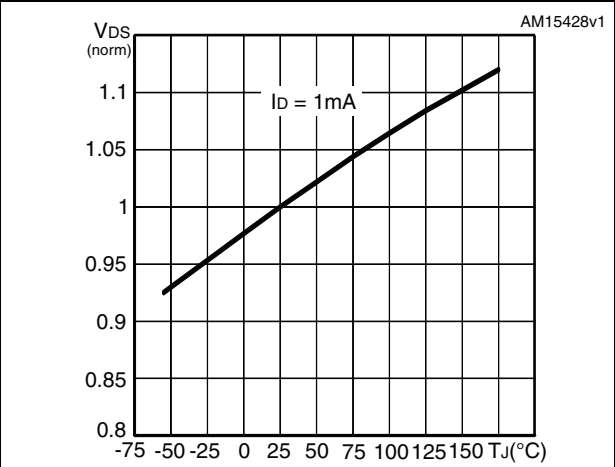


Figure 10. Normalized gate threshold voltage vs temperature

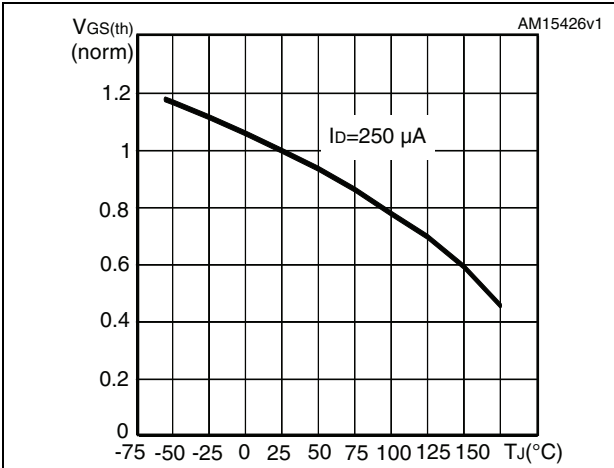


Figure 11. Normalized on-resistance vs temperature

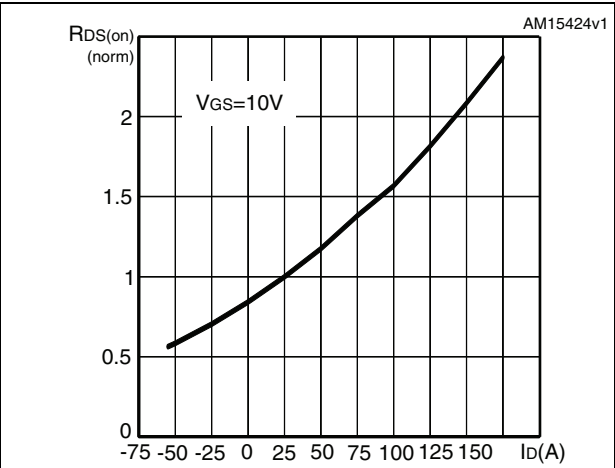
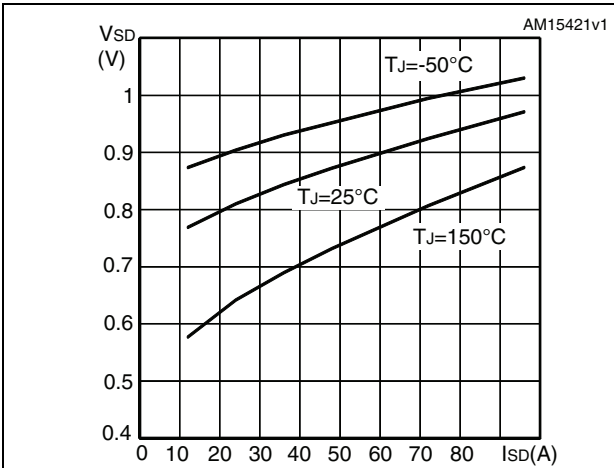
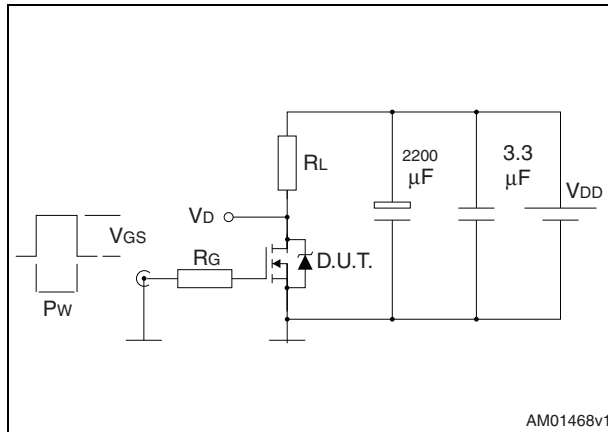


Figure 12. Source-drain diode forward characteristics

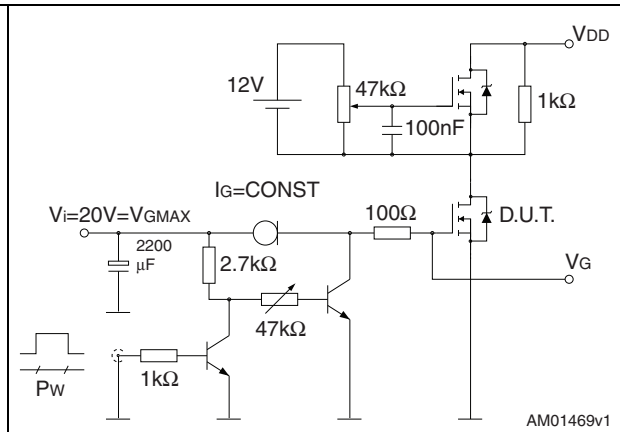


### 3 Test circuits

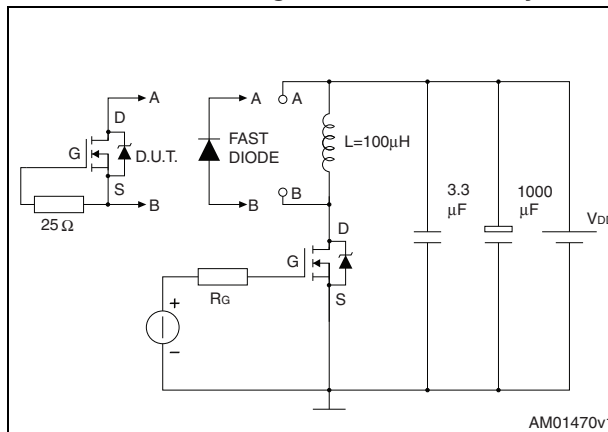
**Figure 13. Switching times test circuit for resistive load**



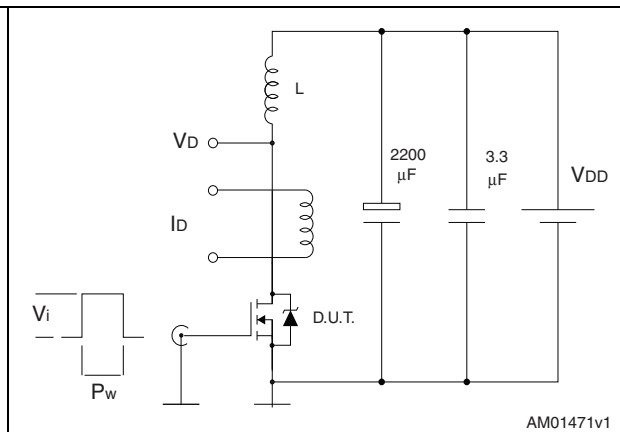
**Figure 14. Gate charge test circuit**



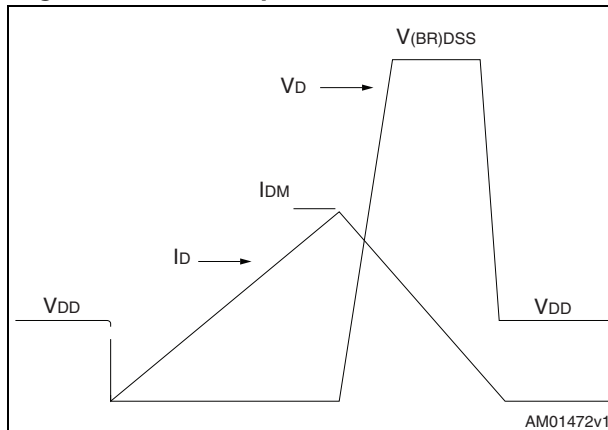
**Figure 15. Test circuit for inductive load switching and diode recovery times**



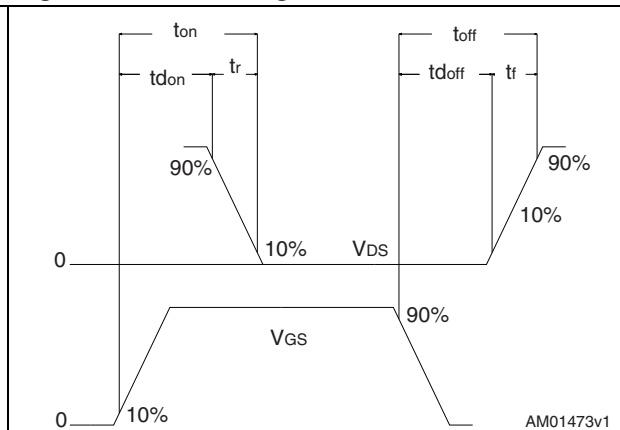
**Figure 16. Unclamped inductive load test circuit**



**Figure 17. Unclamped inductive waveform**



**Figure 18. Switching time waveform**



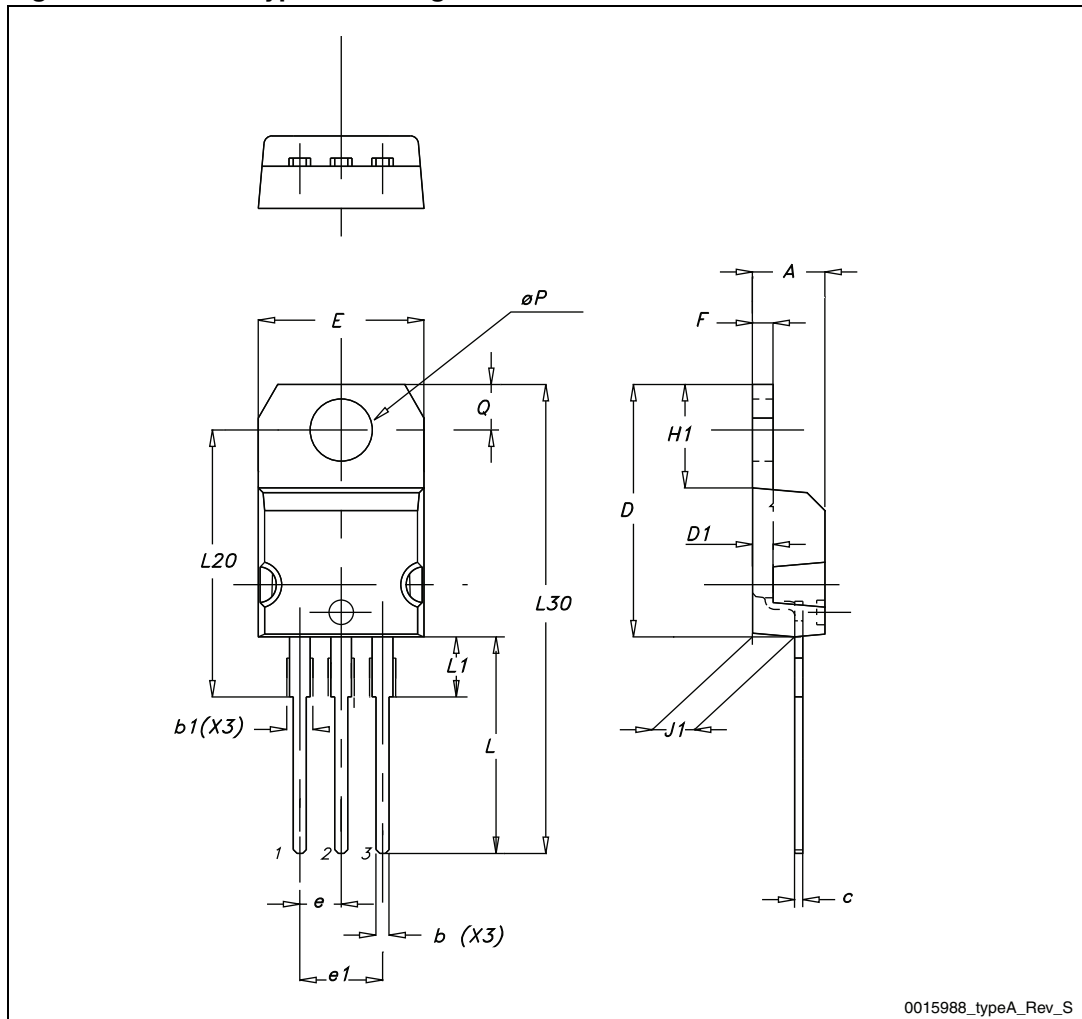
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK<sup>®</sup> is an ST trademark.

Table 8. TO-220 type A mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.40  |       | 4.60  |
| b    | 0.61  |       | 0.88  |
| b1   | 1.14  |       | 1.70  |
| c    | 0.48  |       | 0.70  |
| D    | 15.25 |       | 15.75 |
| D1   |       | 1.27  |       |
| E    | 10    |       | 10.40 |
| e    | 2.40  |       | 2.70  |
| e1   | 4.95  |       | 5.15  |
| F    | 1.23  |       | 1.32  |
| H1   | 6.20  |       | 6.60  |
| J1   | 2.40  |       | 2.72  |
| L    | 13    |       | 14    |
| L1   | 3.50  |       | 3.93  |
| L20  |       | 16.40 |       |
| L30  |       | 28.90 |       |
| ØP   | 3.75  |       | 3.85  |
| Q    | 2.65  |       | 2.95  |

Figure 19. TO-220 type A drawing



## 5 Revision history

**Table 9. Document revision history**

| Date        | Revision | Changes        |
|-------------|----------|----------------|
| 06-Dec-2012 | 1        | First release. |

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